

# IEEE 802.3 Criteria for Standards Development (CSD)

The IEEE 802 Criteria for Standards Development (CSD) are defined in Clause 14 of the IEEE 802 LAN/MAN Standards Committee (LMSC) Operations Manual. The criteria include project process requirements (“Managed Objects”) and 5 Criteria (5C) requirements. The 5C are supplemented by subclause 7.2 ‘Five Criteria’ of the ‘Operating Rules of IEEE Project 802 Working Group 802.3, CSMA/CD LANs’.

The following are the CSD Responses in relation to the IEEE  
P802.3<sup>db</sup> PAR

Items required by the IEEE 802 CSD are shown in Black text and supplementary items required by IEEE 802.3 are shown in blue text.

# Managed Objects

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Describe the plan for developing a definition of managed objects. The plan shall specify one of the following:

- a) The definitions will be part of this project.
  - b) The definitions will be part of a different project and provide the plan for that project or anticipated future project.
  - c) The definitions will not be developed and explain why such definitions are not needed.
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- The definition of protocol independent managed objects, to be included in Clause 30 of IEEE Std 802.3, will be part of this project.

# Coexistence

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**A WG proposing a wireless project shall demonstrate coexistence through the preparation of a Coexistence Assurance (CA) document unless it is not applicable.**

- a) Will the WG create a CA document as part of the WG balloting process as described in Clause 13?
- b) If not, explain why the CA document is not applicable

- A CA document is not applicable because the proposed project is not a wireless project.

# Broad Market Potential

Each proposed IEEE 802 LMSC standard shall have broad market potential. At a minimum, address the following areas:

a) Broad sets of applicability.

b) Multiple vendors and numerous users.

- **Broad Sets of Applicability:**

- Electrical signaling data rates on both switches and server network interface cards are expected to move to 100 Gb/s per lane in the next few years.
- The trends of increasing switch radix and decreasing server count-per-rack combine to favor architectures connecting servers to switches across multiple racks, requiring longer reaches over optical fiber (tens of meters) than can be supported by passive copper cables (< 2 m), for 100 Gb/s lanes.
- Short reach, lower cost optical modules using 100 Gb/s signaling can serve as low cost interconnects between servers and switches over tens of meters in cloud data centers, AI/machine learning clusters, high-performance computing applications, and in large enterprise and carrier data centers. Implementations could be developed to support breakout topologies.
- Short reach, lower cost optical modules using 100 Gb/s signaling can also serve as low cost interconnects for a significant portion of switch-to-switch links in cloud data centers.

- **Multiple vendors and numerous users:**

- 55 individuals affiliated with 38 companies were supporters for “Lower cost, short reach, optical PHYs using 100 Gb/s wavelengths” Call For Interest (CFI), including cloud and enterprise end-users. 65 participants attended the CFI consensus presentation. 55 participants voted in favor of forming a Study Group. 22 individuals from 18 companies indicated participation in this project.
- It is anticipated that there will be sufficient participation to effectively complete the standardization process including representatives from end-users, equipment manufacturers and component suppliers.

# Compatibility

Each proposed IEEE 802 LMSC standard should be in conformance with IEEE Std 802, IEEE 802.1AC, and IEEE 802.1Q. If any variances in conformance emerge, they shall be thoroughly disclosed and reviewed with IEEE 802.1 WG prior to submitting a PAR to the Sponsor.

- a) Will the proposed standard comply with IEEE Std 802, IEEE Std 802.1AC and IEEE Std 802.1Q?
- b) If the answer to a) is “no”, supply the response from the IEEE 802.1 WG.
- c) **Compatibility with IEEE Std 802.3**
- d) **Conformance with the IEEE Std 802.3 MAC**

- As an amendment to IEEE Std 802.3, the proposed project shall comply with IEEE Std 802, IEEE Std 802.1AC and IEEE Std 802.1Q.
- As was the case in previous IEEE Std 802.3 amendments, new physical layers will be defined for 100 Gb/s(, 200 Gb/s,) and 400 Gb/s operation.
- As an amendment to IEEE Std 802.3, the proposed project will conform to the full-duplex operating mode of the IEEE 802.3 MAC.
- By utilizing the existing IEEE Std 802.3 MAC protocol, this proposed amendment will maintain maximum compatibility with the installed base of Ethernet nodes.

# Distinct Identity

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Each proposed IEEE 802 LMSC standard shall provide evidence of a distinct identity. Identify standards and standards projects with similar scopes and for each one describe why the proposed project is substantially different.

Substantially different from other IEEE 802.3 specifications / solutions.

- The proposed amendment will be the first IEEE 802.3 standard defining operation over multimode fiber using 100 Gb/s signaling.

# Technical Feasibility

Each proposed IEEE 802 LMSC standard shall provide evidence that the project is technically feasible within the time frame of the project. At a minimum, address the following items to demonstrate technical feasibility:

- a) Demonstrated system feasibility.
- b) Proven similar technology via testing, modeling, simulation, etc.
- c) Confidence in reliability.

- IEEE 802.3 has already established 100 Gb/s, 200 Gb/s, and 400 Gb/s MAC specifications suitable for 100 Gb/s per wavelength PHY operation in IEEE Std 802.3bs-2017 and IEEE Std 802.3cd-2018.
- The principle of supporting different PMD types from a common MAC specification has been amply demonstrated in IEEE 802.3.
- The principle of building equipment that supports IEEE 802.3 networks operating at different Ethernet rates has been amply demonstrated by a broad set of product offerings.
- The proposed project will build on the array of Ethernet component and system design experience, and the broad knowledge base of Ethernet network operation
  - Vertical Cavity Surface Emitting Laser (VCSEL)-MMF links using 50 Gb/s (25 GBd PAM4) signaling were developed in IEEE P802.3cd and IEEE P802.3cm, and specifications for 400 Gb/s over parallel MMF were developed.
  - Individuals affiliated with component vendors have presented simulations and data demonstrating the feasibility of 100 Gb/s (50 GBd PAM4) signaling VCSEL-based multimode links.
- The reliability of Ethernet components and systems can be projected in the target environments with a high degree of confidence.

# Economic Feasibility

Each proposed IEEE 802 LMSC standard shall provide evidence of economic feasibility. Demonstrate, as far as can reasonably be estimated, the economic feasibility of the proposed project for its intended applications. Among the areas that may be addressed in the cost for performance analysis are the following:

- a) **Balanced costs (infrastructure versus attached stations).**
  - b) **Known cost factors.**
  - c) **Consideration of installation costs.**
  - d) **Consideration of operational costs (e.g., energy consumption).**
  - e) **Other areas, as appropriate.**
- The cost factors for Ethernet components and systems are well known. Re-use of common technologies from prior Ethernet projects will allow economies of scale to reduce cost.
  - In consideration of installation costs, the project is expected to use proven and familiar optical fiber media types.
  - The historical low cost and low power advantages associated with VCSEL-MMF links are expected to be preserved when increasing the optical lane rate from 50 to 100 Gb/s
  - Higher speed 100 Gb/s signaling over MMF will lead to reduced lane counts, reduced fiber and component counts, reduced complexity, and lower cost than previously standardized PMDs based on 50 Gb/s signaling.
  - Use of transceivers developed for this project will promote re-use of the installed base of MMF cabling.
  - Network design, installation and maintenance costs are minimized by preserving network architecture, management, and software.